

to withstand a high voltage (approximately 32,000 volts) that is applied to the second electrode 26. One end of the resistor 50 is electrically connected to the first electrode 24 by means of a first conductor 54. The other end of the resistor 50 is electrically connected by means of second conductor 56 to the second electrode 26. Each plate 46, successively spaced from the first electrode 24, is electrically connected, by means of electrical taps 52, to the resistor 50 at a point of successively greater resistance with respect to the one end of the resistor 50.

After the electron gun 10 is assembled inside a cathode ray tube (not shown), the bulb spacers 44 contact the inside surface of the tube establishing an electrical contact between that surface and the second electrode 26. When the electron gun 10 is operating, a first voltage, of about 4,000 volts, is applied to the first electrode 24 and a second voltage, in the range of 25,000 to 32,000 volts, is applied to the inside surface of the cathode ray tube. All of the voltages are with reference to the control grid electrode 16. The second voltage is also applied to the second electrode 26 by means of bulb spacers 44 and shield cup 42, creating a voltage difference between said first and second electrodes. This voltage difference is distributed to each plate 46 by means of resistor 50, the two conductors 54 and 56, and the taps 52 so that each plate 46, spaced successively further from the first electrode 24, is at a higher voltage than the previous plate. The distribution of the voltages is such that each plate 46 is maintained at approximately the same potential as the equipotential line at that point in an electrostatic field established in a large aperture electron lens.

There are two basic arrangements for establishing the electrostatic field between the first and second electrodes 24 and 26. The first arrangement forms a uniform electrostatic field in which the equipotential lines are equally spaced. In forming this field, the voltage applied to each plate 46 is proportional to the spacing of that plate from the two focusing electrodes 24 and 26. In this case, the taps 52 are spaced on resistor 50 proportionally to the plate spacing. The uniform field closely approximates the electrostatic field in the large aperture lens. However, in the large aperture lens the field is not exactly uniform. In fact, the equipotential lines near the beam path are closer to one another near the center of the lens gap than elsewhere between the first and second electrodes 24 and 26. A second arrangement more accurately duplicates this non-uniform field by applying the voltage disproportionately to the plate spacing. This can be accomplished by spacing either the plates 46 in the gap or the taps 52 on the resistor 50 evenly while spacing the other unevenly. In the second arrangement, the plates 46 are maintained at a voltage equivalent to the potential at their position in the electrostatic field of the large aperture lens.

The improved electron gun 10 has a focusing lens with the same properties as the large aperture electron focusing lens. The inclusion of the plates 46 stabilizes the field permitting a large focusing gap while minimiz-

ing external interference to within acceptable limits. This large focusing gap increases the focal length of the lens which reduces the aberration caused by the lens. By placing the resistor 50 within the cathode ray tube and electrically connecting the resistor to the first and second electrodes 24 and 26, the need for additional high voltage leads extending through the tube envelope is eliminated. This also eliminates possible lead insulation problems which could exist in small neck diameter cathode ray tubes where the leads would be closely spaced, to one another.

What is claimed is:

1. In an electron gun structure for producing and directing at least one electron beam along a beam path, said gun including a cathode, a control grid electrode, a screen grid electrode, a first accelerating and focusing electrode and a second accelerating and focusing electrode, spaced respectively along the beam path, the improvement comprising:

a plurality of spaced electrode plates positioned between said first focusing and accelerating electrode and said second focusing and accelerating electrode for expanding the focusing lens fields in the path of the beam, each plate having an aperture therethrough aligned with said beam path;

supporting means connecting said electrode plates; and

resistive means attached at one end to said first accelerating and focusing electrode and at a second end to said second focusing and accelerating electrode and attached to said spaced electrode plates at spaced points between the ends of said resistive means, said resistive means being on said support means.

2. The device as in claim 1 wherein said device includes:

a plurality of cathodes for producing a plurality of electron beams; and

each of said spaced electrode plates having a plurality of apertures therethrough, each aperture being aligned with a respective beam path.

3. The device as in claim 1 wherein said resistive means comprises a thin film cermet resistor.

4. The device as in claim 1 wherein the cathode, electrodes and electrode plates are mounted between a plurality of parallel support rods.

5. The device as in claim 4 wherein the resistive means is mounted on one of said support rods.

6. The device as in claim 5 wherein the resistive means comprises a thin film cermet resistor bonded to a substrate, said substrate being mounted on one of said support rods.

7. The device as in claim 1 wherein said spaced electrode plates are connected to the resistive means so that the resistance between said spaced electrode plates is proportional to their spacing.

8. The device as in claim 1 wherein said spaced electrode plates are connected to the resistive means so that the resistance between said spaced electrode plates is disproportional to their spacing.

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